# 1 Characteristics

### Table 2. Absolute ratings (limiting values, at 25 °C unless otherwise stated)

Parameter	Value	Unit	
Repetitive peak reverse voltage	25	V	
Forward rms current			А
Average forward current, $\delta=0.5$ square wave	T <sub>c</sub> = 140 °C,	5	А
Surge non repetitive forward current	t <sub>p</sub> = 10 ms sinusoidal	75	А
Repetitive peak avalanche power	$t_p = 10 \ \mu s, T_j = 125 \ ^\circ C$	215	W
Storage temperature range	-65 to +150	°C	
Maximum operating junction temperature <sup>(1)</sup>	150	°C	
	Repetitive peak reverse voltage Forward rms current Average forward current, $\delta = 0.5$ square wave Surge non repetitive forward current Repetitive peak avalanche power Storage temperature range	Repetitive peak reverse voltageForward rms currentAverage forward current, $\delta = 0.5$ square wave $T_c = 140 \text{ °C}$ ,Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$ Repetitive peak avalanche power $t_p = 10 \text{ µs}$ , $T_j = 125 \text{ °C}$ Storage temperature range	Repetitive peak reverse voltage25Forward rms current7Average forward current, $\delta = 0.5$ square wave $T_c = 140 ^{\circ}C$ ,5Surge non repetitive forward current $t_p = 10 ^{\circ}C$ ,5Surge non repetitive forward current $t_p = 10 ^{\circ}C$ ,215Storage temperature range-65 to +150

1.  $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

#### Table 3. Thermal resistance

Symbol	Parameter	Max. value	Unit
R <sub>th(j-c)</sub>	Junction to case	2.5	°C/W

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage current	T <sub>j</sub> = 25 °C	V <sub>R</sub> = V <sub>RRM</sub>	-	-	350	μA
'R`′		T <sub>j</sub> = 125 °C		-	55	115	mA
	Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 5 A	-	-	0.47	V
V <sub>E</sub> <sup>(1)</sup>		T <sub>j</sub> = 125 °C		-	0.31	0.35	
VF`		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 10 A	-	-	0.59	
		T <sub>j</sub> = 125 °C		-	0.41	0.50	

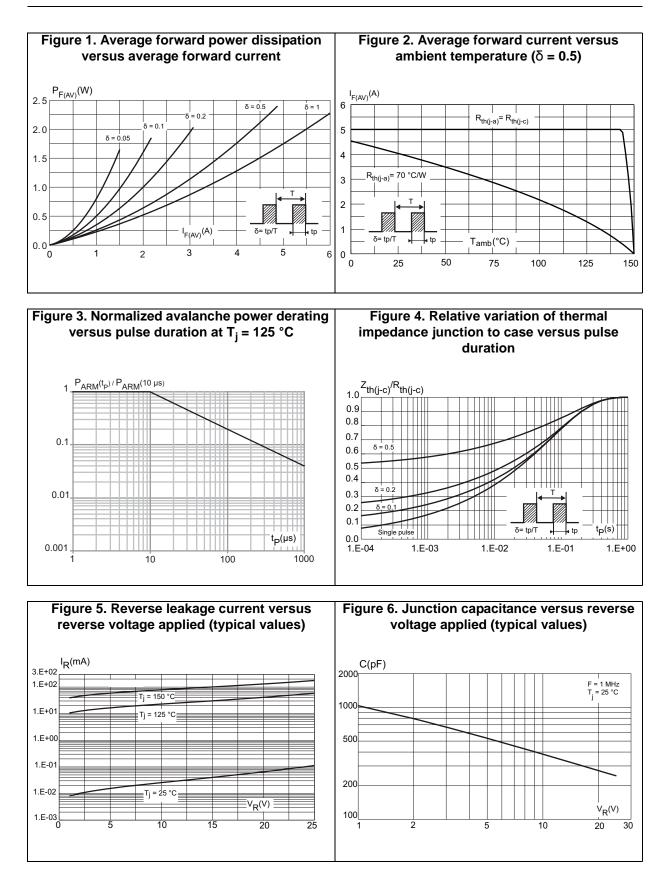
### Table 4. Static electrical characteristics

1. Pulse test:  $t_p = 380 \ \mu s, \ \delta < 2\%$ 

To evaluate the conduction losses use the following equation:

 $P = 0.2 \text{ x } I_{F(AV)} + 0.03 \text{ x } {I_F}^2_{(RMS)}$ 

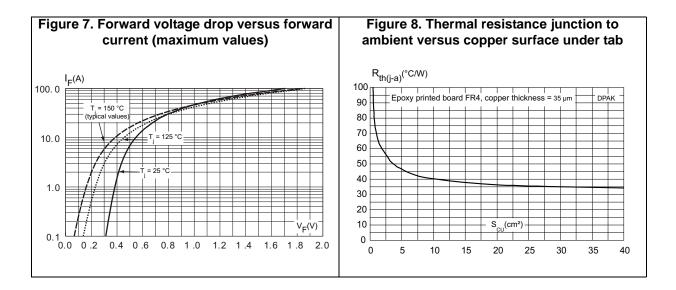




57

DocID3626 Rev 8

3/8



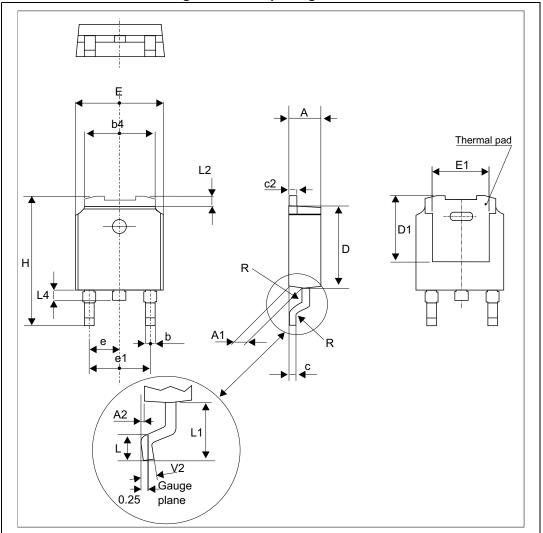


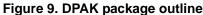
## 2 Package Information

- Epoxy meets UL94,V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

## 2.1 DPAK package information





Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

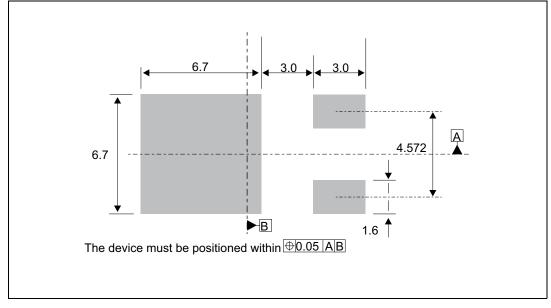


57

Dimensions						
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	2.18		2.40	0.085		0.094
A1	0.90		1.10	0.035		0.043
A2	0.03		0.23	0.001		0.009
b	0.64		0.90	0.025		0.035
b4	4.95		5.46	0.194		0.214
С	0.46		0.61	0.018		0.024
c2	0.46		0.60	0.018		0.023
D	5.97		6.22	0.235		0.244
D1	4.95		5.60	0.194		0.220
E	6.35		6.73	0.250		0.264
E1	4.32		5.50	0.170		0.216
е		2.28			0.090	
e1	4.40		4.70	0.173		0.185
Н	9.35		10.40	0.368		0.409
L	1.00		1.78	0.039		0.070
L2	1		1.27			0.050
L4	0.60		1.02	0.023		0.040
V2	-8°		+8°	-8°		8°

Table 5. DPAK package mechanical data







## **3** Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS5L25B-TR	STPS5 L25B	DPAK	0.32 g	2500	Tape and reel

# 4 Revision history

Date	Revision Changes	
Jul-2003	5A	Previous release.
15-Apr-2008	6	Reformatted to current standard. Corrected order code in <i>Table 5</i> .
08-Jan-2015	7	Updated package information and reformatted to current standard.
15-May-2017	8	Updated DPAK package information and reformatted to current standard.



#### IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2017 STMicroelectronics - All rights reserved

